

PMEG3005ELD

0.5 A low V_F MEGA Schottky barrier rectifier Rev. 1 — 12 April 2011

Product data sheet

Product profile

1.1 General description

Planar Maximum Efficiency General Application (MEGA) Schottky barrier rectifier with an integrated guard ring for stress protection, encapsulated in a SOD882D leadless ultra small Surface-Mounted Device (SMD) plastic package with visible and solderable side

1.2 Features and benefits

Forward current: I_F ≤ 0.5 A

Reverse voltage: V_R ≤ 30 V

Low forward voltage: V_F ≤ 500 mV

AEC-Q101 qualified

Ultra small and leadless SMD plastic package

Solderable side pads

Package height typ. 0.37 mm

1.3 Applications

- Low voltage rectification
- High efficiency DC-to-DC conversion
- Switch mode power supply
- Reverse polarity protection
- Low power consumption applications

1.4 Quick reference data

Table 1. Quick reference data

Parameter	Conditions	Min	Тур	Max	Unit
average forward current	square wave; $\delta = 0.5$; $f = 20 \text{ kHz}$				
	$T_{amb} \le 75 ^{\circ}C$	<u>[1]</u> _	-	0.5	Α
	T _{sp} ≤ 130 °C	-	-	0.5	Α
reverse current	V _R = 10 V	-	15	200	μА
reverse voltage		-	-	30	V
forward voltage	$I_F = 500 \text{ mA}$	[2] _	450	500	mV
	average forward current reverse current reverse voltage	$\begin{array}{c} \text{average forward} \\ \text{current} \\ \end{array} \begin{array}{c} \text{square wave; } \delta = 0.5; \\ f = 20 \text{ kHz} \\ \hline \\ T_{amb} \leq 75 \text{ °C} \\ \hline \\ T_{sp} \leq 130 \text{ °C} \\ \end{array}$ $\text{reverse current} V_R = 10 \text{ V}$ reverse voltage	$\begin{array}{c} \text{average forward} \\ \text{current} \\ \end{array} \begin{array}{c} \text{square wave; } \delta = 0.5; \\ f = 20 \text{ kHz} \\ \\ \hline T_{amb} \leq 75 ^{\circ}\text{C} \\ \hline T_{sp} \leq 130 ^{\circ}\text{C} \\ \end{array} \begin{array}{c} \text{[1]} \ - \\ \\ \text{reverse current} \\ \text{reverse voltage} \\ \end{array} \begin{array}{c} \text{-} \\ \end{array}$	$\begin{array}{c} \text{average forward} \\ \text{current} \\ \end{array} \begin{array}{c} \text{square wave; } \delta = 0.5; \\ f = 20 \text{ kHz} \\ \\ \hline T_{amb} \leq 75 ^{\circ}\text{C} \\ \hline T_{sp} \leq 130 ^{\circ}\text{C} \\ \end{array} \begin{array}{c} \text{[1]} \ - \\ - \\ - \\ \end{array} \\ \text{reverse current} \\ V_{R} = 10 V \\ \end{array} \begin{array}{c} - \\ 15 \\ \end{array}$	$\begin{array}{c} \text{average forward} \\ \text{current} \\ \end{array} \begin{array}{c} \text{square wave; } \delta = 0.5; \\ f = 20 \text{ kHz} \\ \hline \\ T_{amb} \leq 75 ^{\circ}\text{C} \\ \hline \\ T_{sp} \leq 130 ^{\circ}\text{C} \\ \end{array} \begin{array}{c} \text{[1]} \ - \\ - \\ 0.5 \\ \hline \\ \text{reverse current} \\ \end{array} \begin{array}{c} V_{R} = 10 \text{V} \\ \end{array} \begin{array}{c} - \\ 15 \\ 200 \\ \hline \\ \text{reverse voltage} \\ \end{array} \begin{array}{c} 30 \\ \end{array}$

^[1] Device mounted on an FR4 Printed-Circuit Board (PCB), single-sided copper, tin-plated, mounting pad for cathode 1 cm².



^[2] Pulse test: $t_p \le 300 \ \mu s$; $\delta \le 0.02$.

2. Pinning information

Table 2. Pinning

Pin	Description	Simplified outline Graphic symbol
1	cathode	[1]
2	anode	1 1 2 sym001
		Transparent top view

^[1] The marking bar indicates the cathode.

3. Ordering information

Table 3. Ordering information

Type number	Package					
	Name	Description	Version			
PMEG3005ELD	-	leadless ultra small plastic package; 2 terminals; body 1 \times 0.6 \times 0.4 mm	SOD882D			

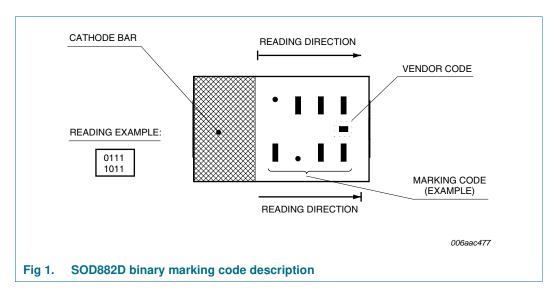
4. Marking

Table 4. Marking codes

Type number	Marking code ^[1]
PMEG3005ELD	0011 0000

^[1] For SOD882D binary marking code description, see Figure 1.

4.1 Binary marking code description



5. Limiting values

Table 5. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134).

Symbol	Parameter	Conditions	Min	Max	Unit
V_R	reverse voltage		-	30	V
I _{F(AV)}	average forward current	square wave; $\delta = 0.5$; $f = 20 \text{ kHz}$			
		$T_{amb} \le 75 ^{\circ}C$	<u>[1]</u> -	0.5	Α
		T _{sp} ≤ 130 °C	-	0.5	Α
I _{FRM}	repetitive peak forward current	$t_p \leq \text{1 ms; } \delta \leq \text{0.25}$	-	1	Α
I _{FSM}	non-repetitive peak forward current	square wave; $t_p = 8 \text{ ms}$	[2] _	3	Α
P _{tot}	total power dissipation	$T_{amb} \le 25 ^{\circ}C$	[3] _	340	mW
			[1] -	660	mW
			<u>[4]</u> _	1000	mW
Tj	junction temperature		-	150	°C
T _{amb}	ambient temperature		-55	+150	°C
T _{stg}	storage temperature		-65	+150	°C

^[1] Device mounted on an FR4 PCB, single-sided copper, tin-plated, mounting pad for cathode 1 cm².

^[2] $T_j = 25$ °C prior to surge.

^[3] Device mounted on an FR4 PCB, single-sided copper, tin-plated and standard footprint.

^[4] Device mounted on a ceramic PCB, Al₂O₃, standard footprint.

6. Thermal characteristics

Table 6. Thermal characteristics

Symbol	Parameter	Conditions		Min	Тур	Max	Unit
ιιι(j-α)	thermal resistance from	in free air	[1][2]	-	-	370	K/W
	junction to ambient		[1][3]	-	-	190	K/W
			[1][4]	-	-	125	K/W
$R_{th(j\text{-sp})}$	thermal resistance from junction to solder point		<u>[5]</u>	-	-	50	K/W

- [1] For Schottky barrier diodes thermal runaway has to be considered, as in some applications the reverse power losses P_R are a significant part of the total power losses.
- [2] Device mounted on an FR4 PCB, single-sided copper, tin-plated and standard footprint.
- [3] Device mounted on an FR4 PCB, single-sided copper, tin-plated, mounting pad for cathode 1 cm².
- [4] Device mounted on a ceramic PCB, Al₂O₃, standard footprint.
- [5] Soldering point of cathode tab.

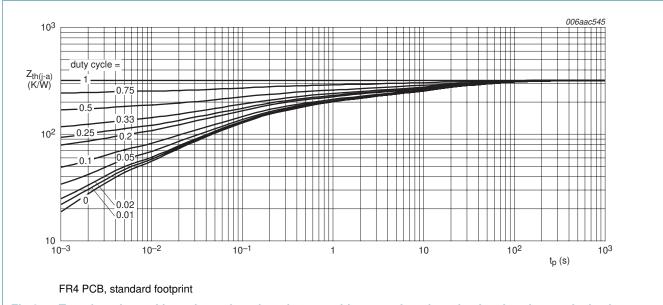


Fig 2. Transient thermal impedance from junction to ambient as a function of pulse duration; typical values

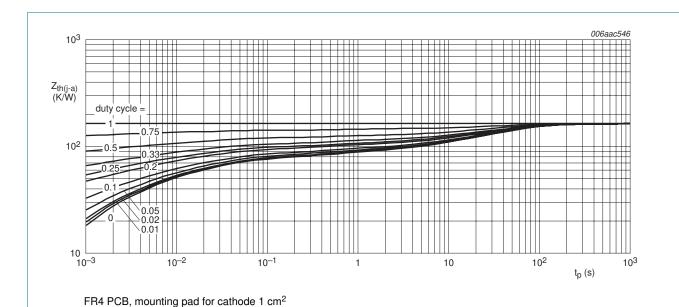
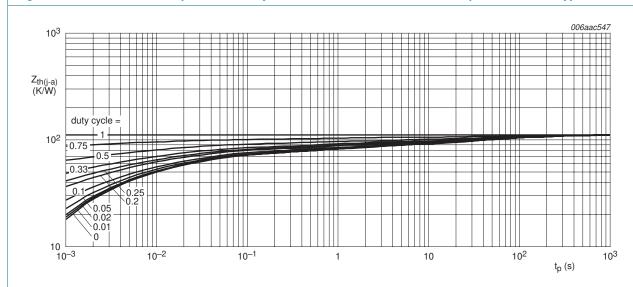


Fig 3. Transient thermal impedance from junction to ambient as a function of pulse duration; typical values



Ceramic PCB, Al₂O₃, standard footprint

Fig 4. Transient thermal impedance from junction to ambient as a function of pulse duration; typical values

7. Characteristics

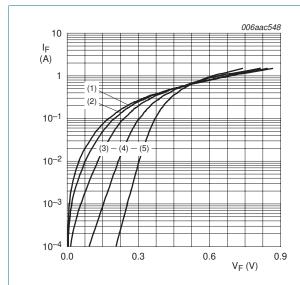
Table 7. Characteristics

T_{amb} = 25 °C unless otherwise specified.

· anib – =0	o umoco cutormos oposmou.					
Symbol	Parameter	Conditions	Min	Тур	Max	Unit
V_{F}	forward voltage		<u>[1]</u>			
		$I_F = 0.1 \text{ mA}$	-	90	180	mV
		$I_F = 1 \text{ mA}$	-	150	200	mV
		I _F = 10 mA	-	210	270	mV
	I _F = 100 mA	-	300	360	mV	
		I _F = 500 mA	-	450	500	mV
I _R	reverse current	V _R = 10 V	-	15	200	μΑ
		V _R = 30 V	-	80	500	μΑ
C_d	diode capacitance	$V_R = 1 V$; $f = 1 MHz$	-	21	30	pF
t _{rr}	reverse recovery time		[2] -	6	-	ns

[1] Pulse test: $t_p \le 300~\mu s;~\delta \le 0.02.$

[2] When switched from I_F = 10 mA to I_R = 10 mA; R_L = 100 Ω ; measured at I_R = 1 mA.





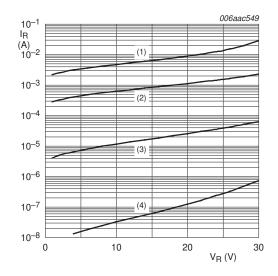
(2)
$$T_i = 125 \,^{\circ}\text{C}$$

(3)
$$T_i = 85 \, ^{\circ}C$$

(4)
$$T_i = 25 \, ^{\circ}C$$

(5) $T_i = -40 \, ^{\circ}C$

Fig 5. Forward current as a function of forward voltage; typical values



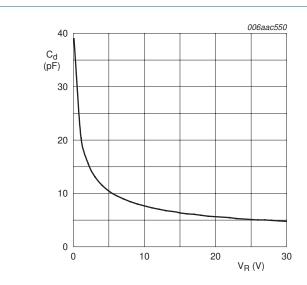
(1) $T_j = 125 \,^{\circ}\text{C}$

(2)
$$T_j = 85 \, ^{\circ}C$$

(3)
$$T_j = 25 \,^{\circ}C$$

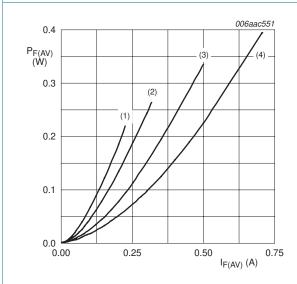
(4) $T_i = -40 \, ^{\circ}C$

Fig 6. Reverse current as a function of reverse voltage; typical values



f = 1 MHz; $T_{amb} = 25 \, ^{\circ}\text{C}$

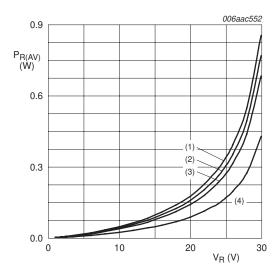
Fig 7. Diode capacitance as a function of reverse voltage; typical values



T_i = 150 °C

- (1) $\delta = 0.1$
- (2) $\delta = 0.2$
- (3) $\delta = 0.5$
- (4) $\delta = 1$

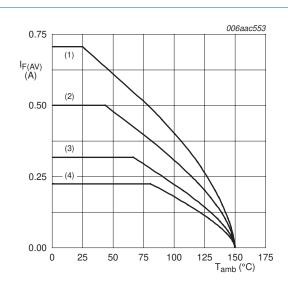
Fig 8. Average forward power dissipation as a function of average forward current; typical values



T_j = 125 °C

- (1) $\delta = 1$
- (2) $\delta = 0.9$
- (3) $\delta = 0.8$
- (4) $\delta = 0.5$

Fig 9. Average reverse power dissipation as a function of reverse voltage; typical values

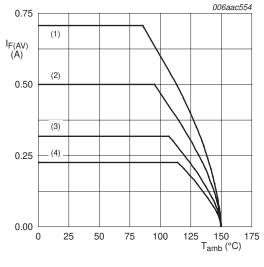


FR4 PCB, standard footprint

$$T_i = 150 \, ^{\circ}C$$

- (1) $\delta = 1$; DC
- (2) $\delta = 0.5$; f = 20 kHz
- (3) $\delta = 0.2$; f = 20 kHz
- (4) $\delta = 0.1$; f = 20 kHz

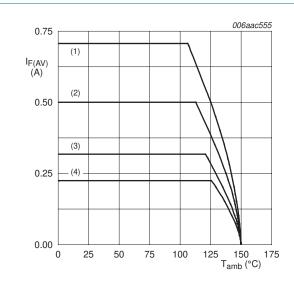
Fig 10. Average forward current as a function of ambient temperature; typical values



FR4 PCB, mounting pad for cathode 1 cm²

- (1) $\delta = 1$; DC
- (2) $\delta = 0.5$; f = 20 kHz
- (3) $\delta = 0.2$; f = 20 kHz
- (4) $\delta = 0.1$; f = 20 kHz

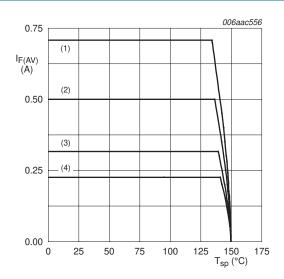
Fig 11. Average forward current as a function of ambient temperature; typical values



Ceramic PCB, Al₂O₃, standard footprint

- (1) $\delta = 1$; DC
- (2) $\delta = 0.5$; f = 20 kHz
- (3) $\delta = 0.2$; f = 20 kHz
- (4) $\delta = 0.1$; f = 20 kHz

Fig 12. Average forward current as a function of ambient temperature; typical values

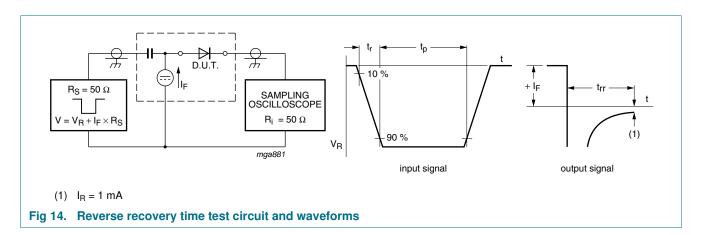


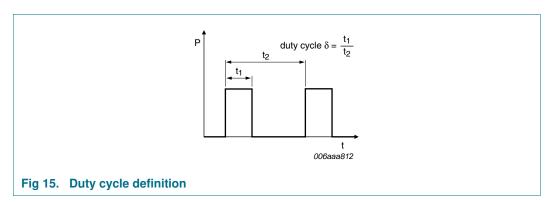
T_i = 150 °C

- (1) $\delta = 1$; DC
- (2) $\delta = 0.5$; f = 20 kHz
- (3) $\delta = 0.2$; f = 20 kHz
- (4) $\delta = 0.1$; f = 20 kHz

Fig 13. Average forward current as a function of solder point temperature; typical values

8. Test information



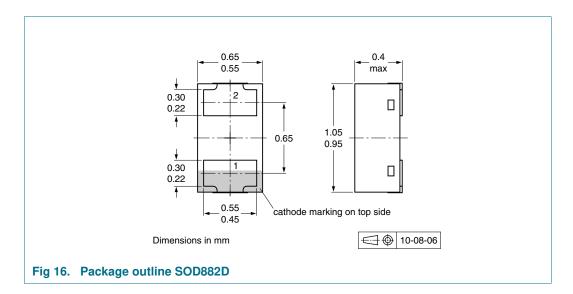


The current ratings for the typical waveforms as shown in Figure 10, 11, 12 and 13 are calculated according to the equations: $I_{F(AV)} = I_M \times \delta$ with I_M defined as peak current, $I_{RMS} = I_{F(AV)}$ at DC, and $I_{RMS} = I_M \times \sqrt{\delta}$ with I_{RMS} defined as RMS current.

8.1 Quality information

This product has been qualified in accordance with the Automotive Electronics Council (AEC) standard *Q101 - Stress test qualification for discrete semiconductors*, and is suitable for use in automotive applications.

9. Package outline



10. Packing information

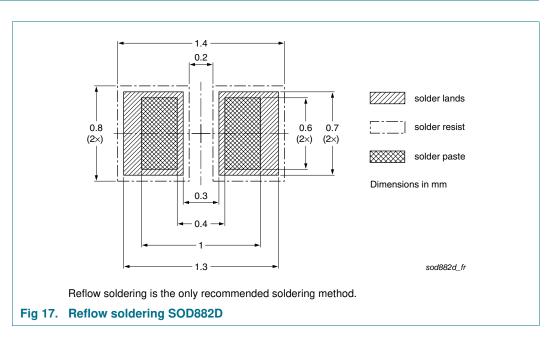
Table 8. Packing methods

The indicated -xxx are the last three digits of the 12NC ordering code.[1]

Type number	Package	Description	Packing quantity
			10000
PMEG3005ELD	SOD882D	2 mm pitch, 8 mm tape and reel	-315

^[1] For further information and the availability of packing methods, see Section 14.

11. Soldering



PMEG3005ELD

All information provided in this document is subject to legal disclaimers.

© Nexperia B.V. 2017. All rights reserved



12. Revision history

Table 9. Revision history

Document ID	Release date	Data sheet status	Change notice	Supersedes
PMEG3005ELD v.1	20110412	Product data sheet	-	-

13. Legal information

13.1 Data sheet status

Document status[1][2]	Product status[3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
Product [short] data sheet	Production	This document contains the product specification.

- [1] Please consult the most recently issued document before initiating or completing a design.
- [2] The term 'short data sheet' is explained in section "Definitions"
- [3] The product status of device(s) described in this document may have changed since this document was published and may differ in case of multiple devices. The latest product status information is available on the Internet at URL http://www.nexperia.com.

13.2 Definitions

Draft — The document is a draft version only. The content is still under internal review and subject to formal approval, which may result in modifications or additions. Nexperia does not give any representations or warranties as to the accuracy or completeness of information included herein and shall have no liability for the consequences of use of such information.

Short data sheet — A short data sheet is an extract from a full data sheet with the same product type number(s) and title. A short data sheet is intended for quick reference only and should not be relied upon to contain detailed and full information. For detailed and full information see the relevant full data sheet, which is available on request via the local Nexperia sales office. In case of any inconsistency or conflict with the short data sheet, the full data sheet shall prevail.

Product specification — The information and data provided in a Product data sheet shall define the specification of the product as agreed between Nexperia and its customer, unless Nexperia and customer have explicitly agreed otherwise in writing. In no event however, shall an agreement be valid in which the Nexperia product is deemed to offer functions and qualities beyond those described in the Product data sheet.

13.3 Disclaimers

Limited warranty and liability — Information in this document is believed to be accurate and reliable. However, Nexperia does not give any representations or warranties, expressed or implied, as to the accuracy or completeness of such information and shall have no liability for the consequences of use of such information.

In no event shall Nexperia be liable for any indirect, incidental, punitive, special or consequential damages (including - without limitation - lost profits, lost savings, business interruption, costs related to the removal or replacement of any products or rework charges) whether or not such damages are based on tort (including negligence), warranty, breach of contract or any other legal theory.

Notwithstanding any damages that customer might incur for any reason whatsoever, Nexperia's aggregate and cumulative liability towards customer for the products described herein shall be limited in accordance with the *Terms and conditions of commercial sale* of Nexperia.

Right to make changes — Nexperia reserves the right to make changes to information published in this document, including without limitation specifications and product descriptions, at any time and without notice. This document supersedes and replaces all information supplied prior to the publication hereof.

Suitability for use — Nexperia products are not designed, authorized or warranted to be suitable for use in life support, life-critical or safety-critical systems or equipment, nor in applications where failure or

malfunction of a Nexperia product can reasonably be expected to result in personal injury, death or severe property or environmental damage. Nexperia accepts no liability for inclusion and/or use of Nexperia products in such equipment or applications and therefore such inclusion and/or use is at the customer's own risk.

Applications — Applications that are described herein for any of these products are for illustrative purposes only. Nexperia makes no representation or warranty that such applications will be suitable for the specified use without further testing or modification.

Customers are responsible for the design and operation of their applications and products using Nexperia products, and Nexperia accepts no liability for any assistance with applications or customer product design. It is customer's sole responsibility to determine whether the Nexperia product is suitable and fit for the customer's applications and products planned, as well as for the planned application and use of customer's third party customer(s). Customers should provide appropriate design and operating safeguards to minimize the risks associated with their applications and products.

Nexperia does not accept any liability related to any default, damage, costs or problem which is based on any weakness or default in the customer's applications or products, or the application or use by customer's third party customer(s). Customer is responsible for doing all necessary testing for the customer's applications and products using Nexperia products in order to avoid a default of the applications and the products or of the application or use by customer's third party customer(s). Nexperia does not accept any liability in this respect.

Limiting values — Stress above one or more limiting values (as defined in the Absolute Maximum Ratings System of IEC 60134) will cause permanent damage to the device. Limiting values are stress ratings only and (proper) operation of the device at these or any other conditions above those given in the Recommended operating conditions section (if present) or the Characteristics sections of this document is not warranted. Constant or repeated exposure to limiting values will permanently and irreversibly affect the quality and reliability of the device.

Terms and conditions of commercial sale — Nexperia products are sold subject to the general terms and conditions of commercial sale, as published at http://www.nexperia.com/profile/terms, unless otherwise agreed in a valid written individual agreement. In case an individual agreement is concluded only the terms and conditions of the respective agreement shall apply. Nexperia hereby expressly objects to applying the customer's general terms and conditions with regard to the purchase of Nexperia products by customer.

No offer to sell or license — Nothing in this document may be interpreted or construed as an offer to sell products that is open for acceptance or the grant, conveyance or implication of any license under any copyrights, patents or other industrial or intellectual property rights.

Export control — This document as well as the item(s) described herein may be subject to export control regulations. Export might require a prior authorization from national authorities.

PMEG3005ELD

All information provided in this document is subject to legal disclaimers.

PMEG3005ELD

0.5 A low V_F MEGA Schottky barrier rectifier

Quick reference data — The Quick reference data is an extract of the product data given in the Limiting values and Characteristics sections of this document, and as such is not complete, exhaustive or legally binding.

13.4 Trademarks

Notice: All referenced brands, product names, service names and trademarks are the property of their respective owners.

14. Contact information

For more information, please visit: http://www.nexperia.com

For sales office addresses, please send an email to: salesaddresses@nexperia.com

PMEG3005ELD

0.5 A low V_F MEGA Schottky barrier rectifier

15. Contents

1	Product profile
1.1	General description 1
1.2	Features and benefits
1.3	Applications
1.4	Quick reference data
2	Pinning information 2
3	Ordering information
4	Marking
4.1	Binary marking code description 2
5	Limiting values 3
6	Thermal characteristics 4
7	Characteristics 6
8	Test information 9
8.1	Quality information 9
9	Package outline
10	Packing information 10
11	Soldering 10
12	Revision history
13	Legal information
13.1	Data sheet status
13.2	Definitions
13.3	Disclaimers
13.4	Trademarks13
14	Contact information
15	Contents 14